

TAI-SAW TECHNOLOGY CO., LTD.

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Product Specifications Approval Sheet

Product Description:	Crystal Unit SMD	3.2x2.5 40.00MHz
TST Part No.: TZ030	8D	
Customer Part No.:_		
Customer signature re	equired	
Company:		
Division:		
Approved by :		
Date:		
		4-1
Checked by:	Yifan Chen	Udan
Approved by:	Kelly Huang	Kelly Huang
Date:	09/14/2016	7

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



TAI-SAW TECHNOLOGY CO., LTD. Crystal Unit SMD 3.2x2.5 40.00MHz

MODEL NO.: TZ0308D REV. NO.: 1

Revise:

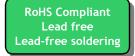
Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Revised by
1	N/A	Initial release	09/14/16'	N/A	Yifan Chen



MODEL NO.: TZ0308D REV. NO.: 1

Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package



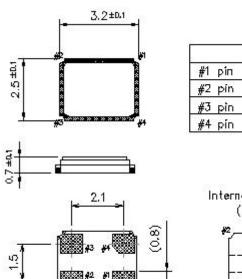
Description and Applications:

Surface mount 3.2mmx2.5mm crystal unit for customer for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

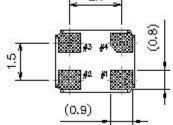
Electrical Specifications:

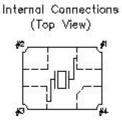
TZ0308D	Specification
Nominal Frequency	40.000000 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-40C to +105C
Operating Temperature Range	-30C to +85C
Frequency Stability over Operating Temperature	+/- 10 ppm (referred to the value at 25C)
Frequency Make Tolerance (FL)	+/- 10 ppm @ 25C +/- 3C
Equivalent Series Resistance (ESR)	30 max.
Nominal Drive Level	100uW max
Shunt Capacitance (Co)	3.0 pF max
Load Capacitance (CL)	9 pF
Aging	+/-2ppm/year
Insulation Resistance	500 M min./DC 100V
Marking	Laser Marking
Unit Weight	0.017+/-0.005 g

Mechanical Dimensions (mm): Base 1

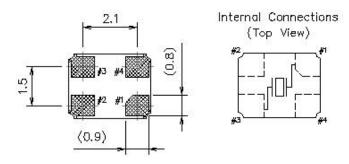


	Pin Connection
#1 pin	IN/OUT
#2 pin	GND
#3 pin	IN/OUT
#4 pin	GND

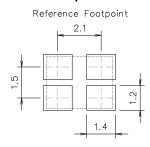




Base 2



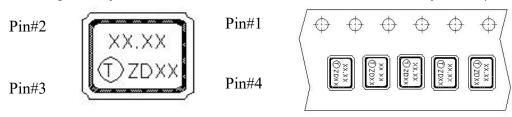
Recommended Land Pattern: (unit: mm)



Marking:

Line 1: Frequency (40.00)

Line 2: TST Logo + Crystal Product Code + Date Code + Traceability code (1 or 2 letters)



The inner vision of Pin#1, Pin#4 side is XTAL blank mounting pad.

TST DCC Release document

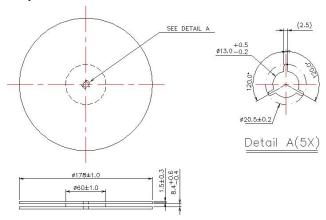
Product Code Table

	2013	2014	2015	2016
Year	2017	2018	2019	2020
	2021	2022	2023	2024
product code	Z	Z	<u>Z</u>	<u>Z</u>

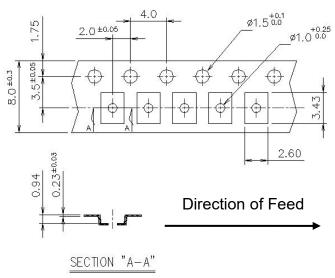
Date Code Table

WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
Α	В	С	D	Е	F	G	Н	I	J	K	L	М
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
N	0	Р	Q	R	S	Т	U	V	W	Х	Υ	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
а	b	С	d	е	f	g	h	i	j	k	I	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	0	р	q	r	s	t	u	٧	w	х	у	z

Reel Dimensions (mm):



Tape Dimensions (mm):



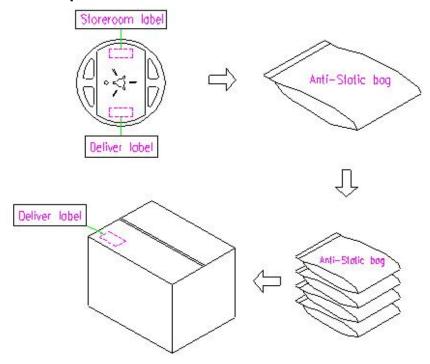
[NOTE]

- 1 UNIT: mm.
- 2 UNLESS OTHERWISE SPECIFIED TOLERANCEON DIM. +/-0.1mm.
- 3 MATERIAL: CONDUCTIVE POLYSTYRENE.
- 4 COLOR: BLACK.
- 5 10 PITCHES CUMULATIVETOLERANCE +/-0.2mm.

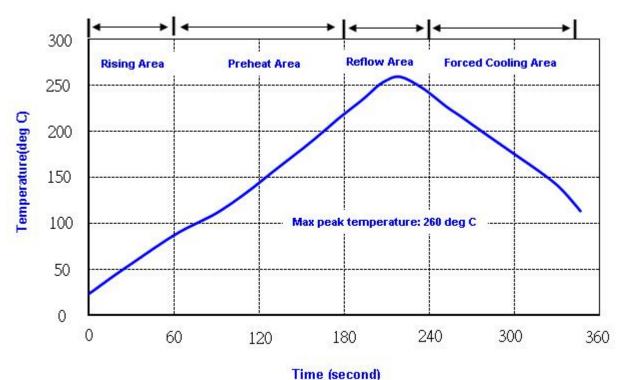
TST DCCRelease document

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec

2. Temperature: 217+/-5 deg C; Time: 90~100 sec

Reliability Specifications

Test name	Test process / method	Reference standard					
Mechanical characteristics							
resistance to Soldering heat	Temp./ Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701					
(IR reflow)	, , , , , , , , , , , , , , , , , , , ,	-300(301)M(II)					
Vibration	Total peak amplitude :1.5mm	MIL-STD 202G					
	Vibration frequency : 10 to 2000 Hz	method 204					
	Sweep period : 20 minute						
	Vibration directions : 3 mutually perpendicular						
Machaniael	Duration : 2 hr / direc. directions : 3 impacts per axis	MIL CTD 2020					
Mechanical Shock		MIL-STD 202G method 213					
SHOCK	Acceleration: 3000g's, +20/-0 % Duration: 0.3 ms (total 18 shocks)	metriod 213					
	Waveform : Half-sine						
Solderability	Solder Temperature:265±5°C	J-STD-002					
	Duration time: 5±0.5 seconds.						
Environmental c							
Thermal Shock	Heat cycle conditions	MIL-STD 883G					
	-40 °C (30min) ←→ 85 °C (30min) * cycle time : 10 times	method 1010.8					
Humidity test	Temperature : 85 ± 2 °C	MIL-STD 202G					
	Relative humidity: 85%	method 103					
	Duration : 96 hours						
Dry heat	Temperature : 125 ± 2 °C	MIL-STD 202G					
(Aging test)	Duration : 168 hours	method 108A					
Cold resistance	Temperature : -40 ± 2 °C	IEC 60068-2-1					
(Low Temp Storage)	Duration : 96 hours						